

Harvatek 3.0mm Round LED LAMP with Holder**HV-A694B/260/SURSYG-F4.0**

Official Product	HV-A694B/260/SURSYG-F4.0 *****	Customer Part No. *****	Data Sheet No. HV-A694B/260/SURSYG-F4.0
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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Compliance and Certification

ISO9002, QS9000 and ISO14001 Certified

RoHS Compliant



Orderable Information

H V - A694B / 260 / SURSYG - F4.0

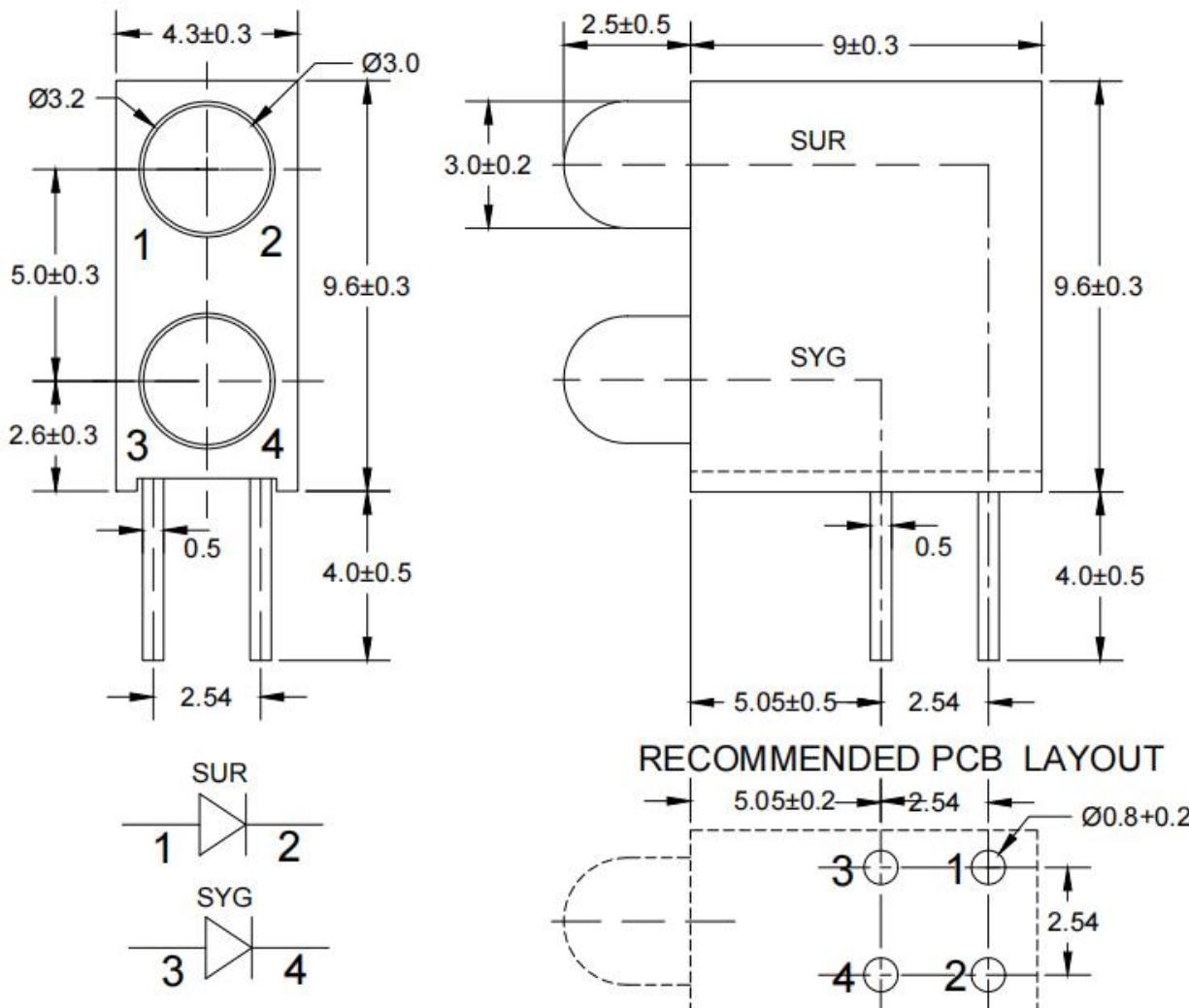
Series Name	Color Code	Remark
HV : HARVATEK	A694B: Array 2 Lamp. 260:3.0mm Round LED LAMP. SURSYG: AlGaInP 620nm Red Chip. AlGaInP 570nm Green Chip. F4.0:HARVATEK Part No.	

Features:

- Stable Color.
- Popular 3.0mm through hole package.
- Red Diffused lens and Green Diffused lens.

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Package Dimensions:



Notes:

1. All dimensions are millimeters.
2. Tolerance is +/-0.25mm unless otherwise noted.
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Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol		Rating	Unit
Forward Current	IF	SUR/SYG	30	mA
Operating Temperature	Topr	SUR/SYG	-40to+85	°C
Storage Temperature	Tstg	SUR/SYG	-40to+85	°C
Soldering Temperature*1	Tsol	SUR/SYG	260	°C
Power Dissipation	Pd	SUR/SYG	75	mW
Reverse Voltage	VR	SUR/SYG	5	V
Peak Forward Current*2	IFp	SUR/SYG	75	mA

*1:Soldering time \leq 5 seconds. *2 $t_w=100\mu$ second $T=10m$ second.

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Electrical and Optical Characteristic

Parameter	Symbol		Condition	Min.	Typ.	Max.	Unit
Forward Voltage	VF	SUR	IF=20 mA	/	2.0	2.4	V
		SYG			2.0	2.4	V
Reverse Current	IR	SUR/SYG	VR= 5 V	/	/	10	µA
Luminous Intensity	IV	SUR	IF=20 mA	60	200	/	mcd
		SYG		25	50		
Viewing Angle	$\theta_{1/2}$	SUR/SYG	IF=20 mA	/	60	/	deg
Peak Wavelength	λ_p	SUR	IF=20 mA	/	630	/	nm
		SYG			575		
Dominant Wavelength	λ_d	SUR	IF=20 mA	/	620	/	nm
		SYG			570		
Spectrum Radiation Bandwidth	$\Delta\lambda$	SUR	IF=20 mA	/	20	/	nm
		SYG		/	20	/	

Notes:

$\theta_{1/2}$ is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

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Specifications for Bin Grading:(SUR)

Iv (mcd)		
Grade	Min.	Max.
Q	60	125
R	100	200
S	160	320
T	250	500
U	400	800

Notes: Luminous intensity: +/-15%.

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Specifications for Bin Grading:(SYG)

I _v (mcd)		
Grade	Min.	Max.
N	25	50
P	40	80
Q	63	125
R	100	200

λ d (nm)		
Grade	Min.	Max.
5	566	569
6	568	571
7	570	573
8	572	575
9	574	577

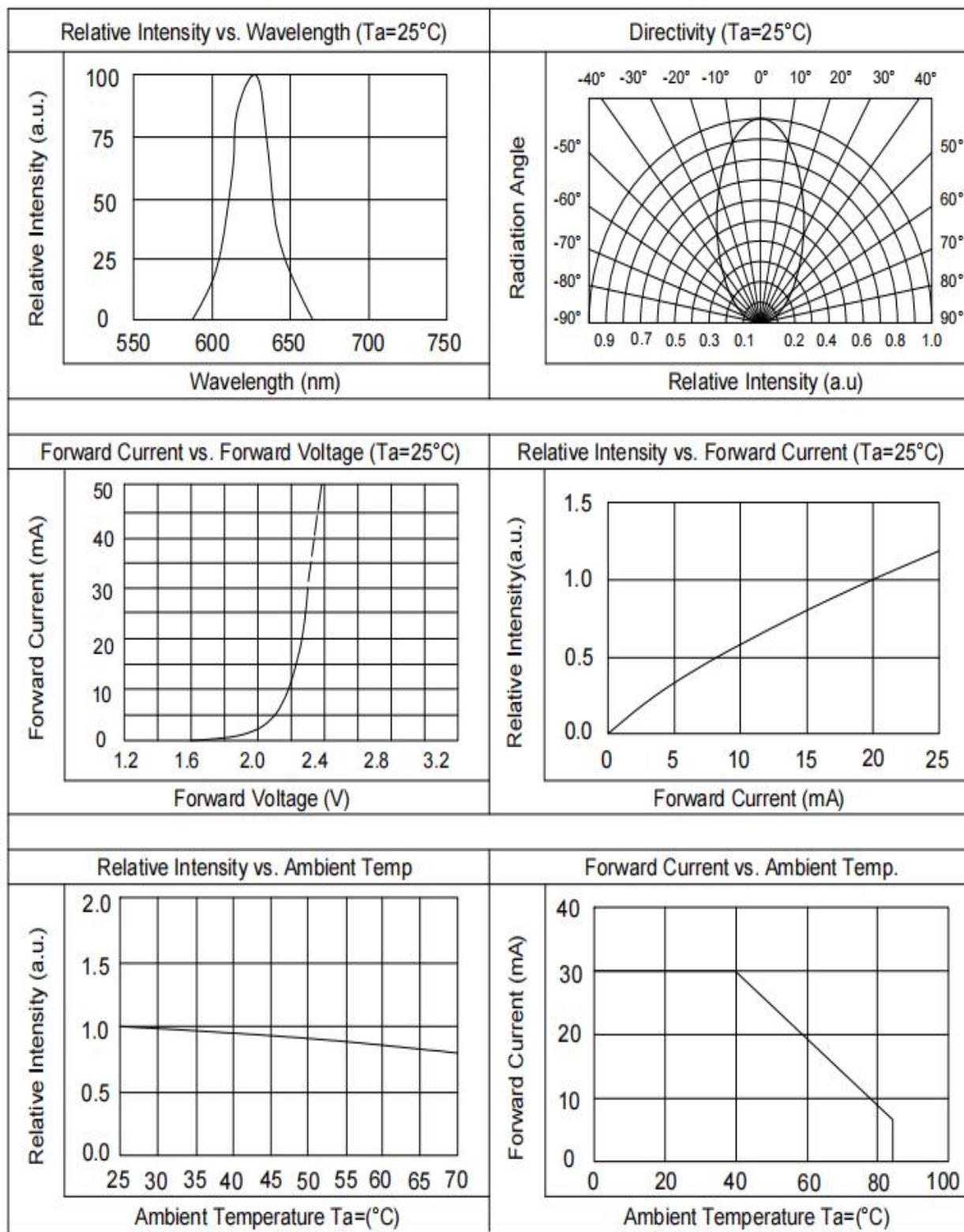
Notes:

1. Luminous intensity: +/-15%.

2. Wavelength: +/-1nm.

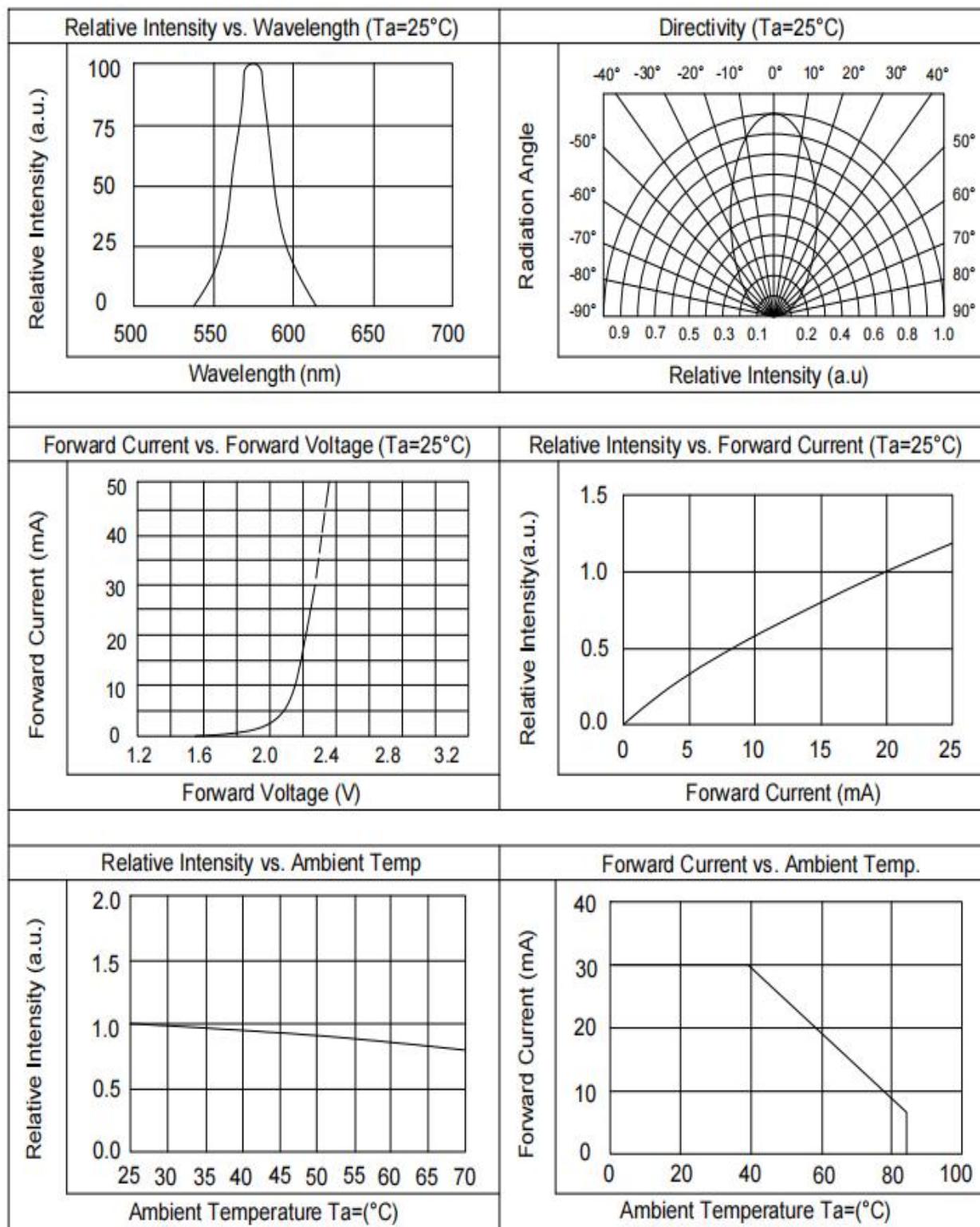
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Typical Electrical / Optical Characteristics Curves(SUR)



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Typical Electrical / Optical Characteristics Curves(SYG)



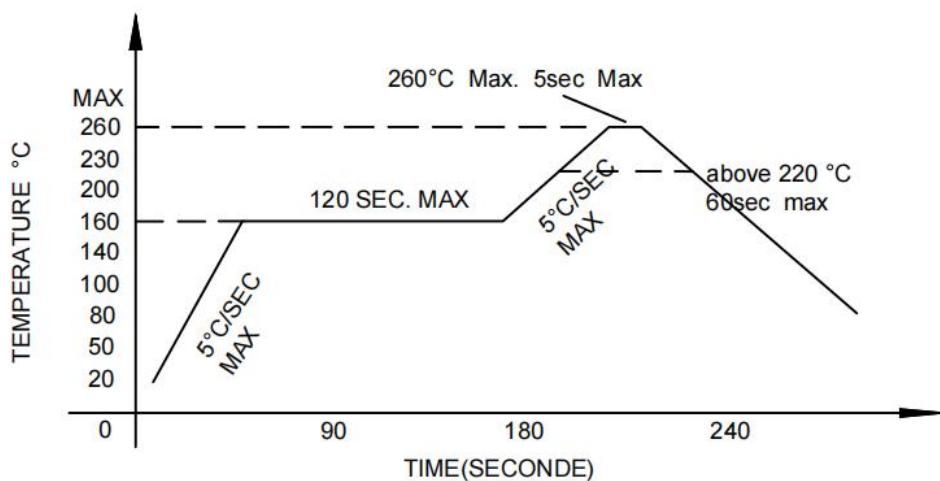
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Soldering condition

1. Careful attention should be paid during soldering. When soldering, leave more than 2mm from solder joint to Led, and soldering beyond the base of the tie bar is recommended.
2. Avoiding applying any stress to the lead frame while the LED are at high temperature particularly when soldering.
3. Dip and hand soldering should not be done more than one time.
4. After soldering the LED, the epoxy bulb should be protected from mechanical shock or vibration until the LED return to room temperature.
5. A rapid-rate process is not recommended for cooling the LED down from the peak temperature.
6. Although the recommended soldering conditions are specified in the above table, dip or hand soldering at the lowest possible temperature is desirable for the LED.
7. Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.

• Recommended soldering conditions

Hand Soldering		Wave Soldering	
Temp. at tip of iron	300°C Max. (30W Max.)	Preheat temp.	160°C Max. (120 sec Max.)
Soldering time	3 sec Max.	Bath temp. & time	260°C Max., 5 sec Max
Distance	2mm Min.(From solder joint to Led)	Distance	2mm Min. (From solder joint to Led)



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Reliability test items and conditions:

The reliability of products shall be satisfied with items listed below.

Confidence level: 97%.

LTPD:3%.

No	Item	Test Conditions	Test Hours/Cycle	Sample Size	Failure Judgment Criteria	Ac/Er
1	Solder Heat	TEMP:260°C±5°C	10 SEC	76 PCS	$Iv \leq Ivt * 0.5$ or $Vf \geq U$ or $Vf \leq L$	0/1
2	Temperature Cycle	H:+100°C 15min ↓ 5min L:-40°C 15min	300 CYCLES	76 PCS		0/1
3	Thermal Shock	H:+100°C 5min ↓ 10sec L:-10°C 5min	300 CYCLES	76 PCS		0/1
4	High Temperature Storage	TEMP:100°C	1000 HRS	76 PCS		0/1
5	Low Temperature Storage	TEMP:-40°C	1000 HRS	76 PCS		0/1
6	DC Operating Life	TEMP:25°C IF=20mA	1000 HRS	76 PCS		0/1
7	High Temperature / High Humidity	85°C/85%RH	1000 HRS	76 PCS		0/1

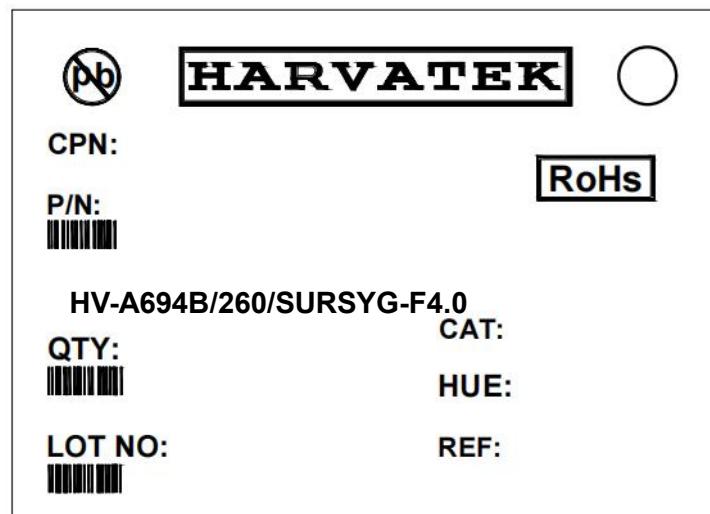
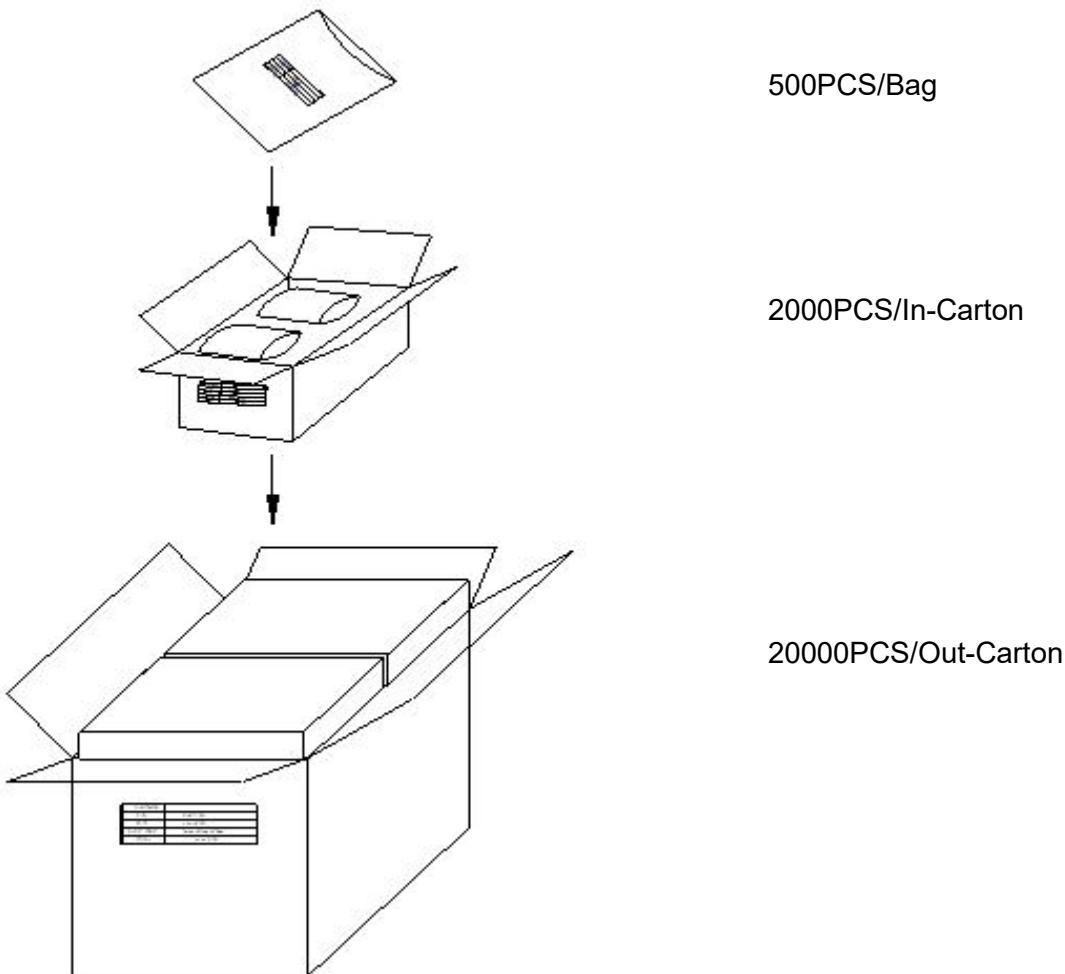
Note: Ivt: To test Iv value of the chip before the reliability test.

Iv: The test value of the chip that has completed the reliability test.

U: Upper Specification Limit.

L: Lower Specification Limit.

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Packing Specification:

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Revision History

Revision	Page	Version No.	Revision Date
Initial Release		1.0	03-25-2021
Modify the glue color	3	1.1	10-26-2023

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